



Micro-D GMLM MasterLatch® Rear Panel Mount, Condensed Board Straight, Vertical Printed Circuit Board Receptacle

Master Latch Rear Panel Mount Receptacle – These Micro-D's provide excellent shock and vibration performance thanks to our innovative MasterLatch® design. Once mated the latching mechanism prevents unwanted separation of mated GMLM connectors.

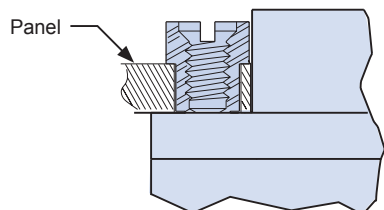
High Performance – GMLMR connectors meet the performance requirements of MIL-DTL-83513. Gold plated TwistPin contacts assure best electrical and mechanical performance.

How To Order GMLMR Connectors

Sample Part Number	GMLMR	2	L	-25	S	CBS	R3	N	T	-.125
Series	GMLMR Micro-D MasterLatch®									
Shell Material and Finish	1 = Cadmium 2 = Nickel 4 = Black Anodize 5 = Gold 6 = Chem Film									
Insulator Material	L = LCP or PPS									
Contact Layout	9 thru 37 See Table II									
Contact Type	S = Socket									
Termination Type	CBS = Condensed Board Straight									
Rear Panel Mount Hardware Option	B = No Hardware R1 = .032 panel R2 = .047 panel, R3 = .062 panel R4 = .093 panel R5 = .125 panel R6 = .080 panel									
O-Ring Type	C = Conductive N = Nitrile									
Threaded Insert	T = Threaded Insert									
Lead Length	.080, .110, .125, .140, .150, .172, .190, .250									

Table I: Jackpost Options

R1 Thru R6



Jackpost for Rear Panel Mounting
Shipped loosely installed. Install with permanent threadlocking compound.

Performance Specifications

Current Rating	3 AMP
DWV	600 VAC Sea level
Insulation Resistance	5000 Megohms Minimum
Contact Resistance	8 Milliohms Maximum
Low Level Contact Resist.	32 Milliohms Maximum
Magnetic Permeability	2 μ Maximum
Operating Temperature	-55° C. to +150° C.
Shock, Vibration	50 g., 20g.
Mating Force	(10 Ounces) X (# of Contacts)

Materials and Finishes

Connector Shell	Aluminum alloy, see ordering info for plating options
Insulator	Liquid Crystal Polymer (LCP) Polyphenylene Sulfide (PPS)
Interfacial Seal	Fluorosilicone Rubber, Blue
Socket Contact	Phos Bronze/Gold Plate
Hardware	Stainless Steel/Passivate
Encapsulant	Epoxy Resin Hysol EE4215

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Micro-D PCB

C

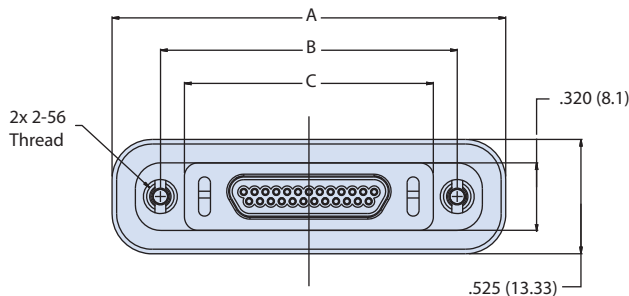
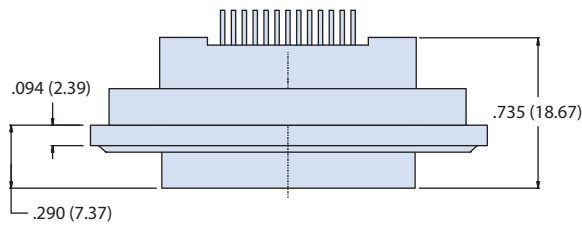
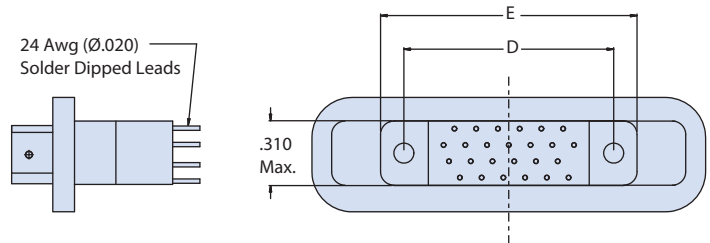
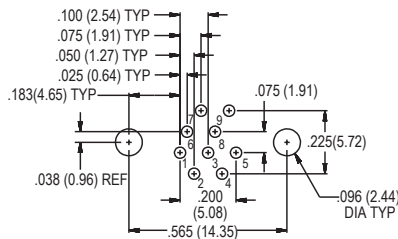


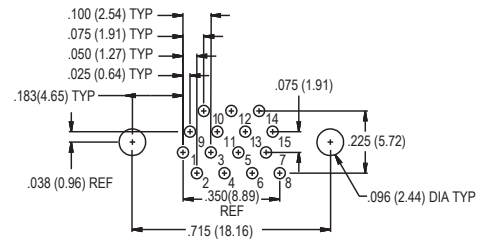
Table II: Dimensions					
Shell Size	A	B ±.003 (.08)	C Max	D ±.003 (.08)	E Max.
9	1.410 (35.81)	0.965 (24.51)	.785 (19.94)	0.565 (14.35)	0.785 (19.94)
15	1.560 (39.62)	1.115 (28.32)	.935 (23.75)	0.715 (18.16)	0.935 (23.75)
21	1.710 (43.43)	1.265 (32.13)	1.085 (27.56)	0.865 (21.97)	1.085 (27.56)
25	1.810 (45.97)	1.365 (34.67)	1.185 (30.10)	0.965 (24.51)	1.185 (30.10)
31	1.960 (49.78)	1.515 (38.48)	1.335 (33.91)	1.115 (28.32)	1.335 (33.91)
37	2.110 (53.59)	1.665 (42.29)	1.485 (37.72)	1.265 (32.13)	1.485 (37.72)



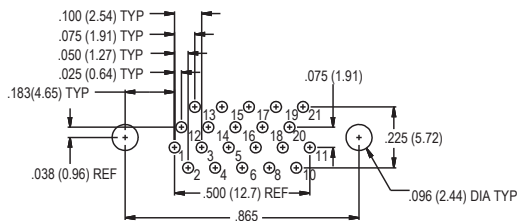
Patterns shown are for connector mounting side of PC board.



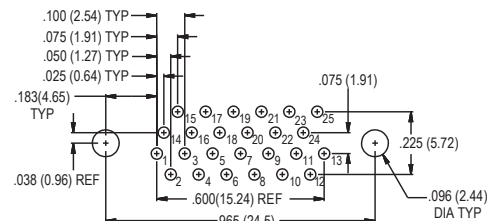
9 SOCKET



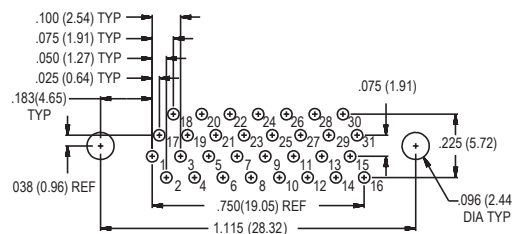
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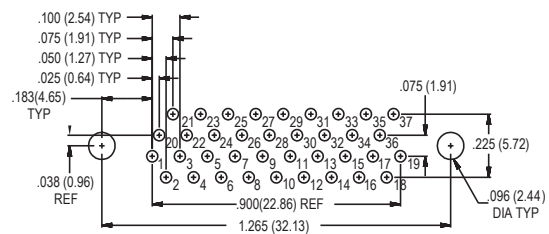
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